



SCF005-1206RB

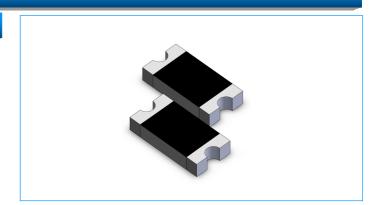
Features

u RoHS Compliant & Halogen Free

 Faster tripping, 1206 Dimension, Surface mountable, Solid state

U Operation Current: 0.05AU Maximum Voltage: 60Vdc

U Operating Temperature: -40°C ~ + 85°C
 U Agency recognition:UL、CSA、TUV



Electrical Parameters

Part Number	Hold Current	Trip Current	Rated Voltage	Max Current	Typical Power		ım Time Trip	Resis	tance
	I hold (A)	I trip (A)	V _{max} (Vdc)	I _{max} (A)	P _{dtyp.} (W)	Current (A)	Time (Sec.)	R _{min} (Ω)	R _{1max} (Ω)
SCF005-1206RB	0.05	0.15	60.0	100	0.4	0.25	1.50	3.600	50.00

I hold = Hold Current. Maximum current device will not trip in 25°C still air.

I _{trip} = Trip Current. Minimum current at which the device will always trip in 25 °C still air.

V_{max} = Maximum operating voltage device can withstand without damage at rated current (Imax).

I max = Maximum fault current device can withstand without damage at rated voltage (Vmax).

P dtyp =Maximum power dissipation when device is in the tripped state in 25 °C still air environment at rated voltage.

R _{1max} = Maximum device resistance is measured one hour post reflow.

Thermal Derating Chart - IH (A)

Model	Maximum ambient operating temperature (℃)								
Model	-40	-20	0	25	40	50	60	70	85
SCF005-1206RB	0.09	0.08	0.06	0.05	0.04	0.036	0.033	0.029	0.02

Test Procedures and Requirements

Test Item	Test Conditions	Accept/Reject Criteria
Resistance	In still air at 25℃	R _{min} ≤R≤R _{max}
Time to Trip	Specified current, V $_{\text{max}}$, 25°C	Tmaximum Time to Trip
Hold Current	30min, at I _H	No trip
Trip Cycle Life	V _{max} , I _{max} , 100cycles	No arcing or burning
Trip Endurance	V _{max} , 1 hour	No arcing or burning





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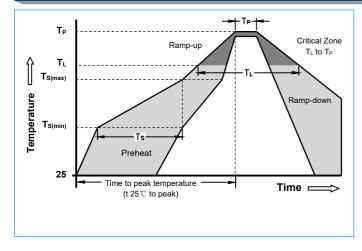
Physical Characteristics

Terminal Materials	Tin-Plated Nickle-copper
Soldering Zone	Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.

Environmental Specifications

Test Item	Test Conditions	Resistance Change
Passive Aging	85℃,1000 hours	±10%
Humidity Aging	85℃/85%RH.1000 hours	±5%
Thermal Shock MIL-STD-202,Method 107G +85℃/-40℃,20 times		-30% typical resistance change
Solvent Resistance MIL-STD-202,Method 215		No change
Vibration	ML-STD-883C,Test Condition A	No change

Soldering Parameters



Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (T _S max to T _P)	3℃/second max.
Preheat : Temperature Min (T _S min) Temperature Max (T _S max) Time (T _S min to T _S max)	150℃ 200℃ 60-120 seconds
Time maintained above: Temperature(T _L) Time (T _L)	217℃ 60-150 seconds
Peak/Classification Temperature(T _P)	260℃
Time within 5 ℃ of actual peak temperature: Time (T _P)	30 seconds max.
Ramp-down Rate	3℃/ second max.
Time 25℃ to Peak Temperature	8 minutes max.

- I Recommended reflow methods: I_R, vapor phase oven, hot air oven, N2 environment for lead-free.
- I Devices are not designed to be wave soldered to the bottom side of the board.
- I Recommended maximum paste thickness is 0.25mm (0.010inch).
- I Devices can be cleaned using standard industry methods and solvents.
- I Soldering temperature profile meets RoHS leadfree process.

Note 1: All temperature refer to topside of the package, measured on the package body surface.

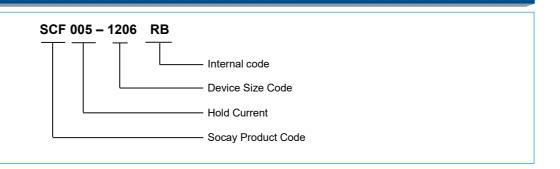
Note 2: If reflow temperature exceed the recommended profile, devices may not meet the performance requirements.





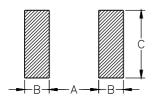
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Part Numbering



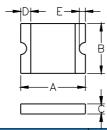
Recommended Solder Pad Layout Dimensions (Unit: mm)

The dimension in the table below provide the recommended pad layout for each SCF005-1206RB device



Device	A	В	С
1206 Series	2.0±0.1	1.0±0.1	1.9±0.1

Product Dimensions (Unit: mm)



Part Number	A	V		3		С	D	E
Fait Nullibei	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
SCF005-1206RB	3.00	3.50	1.50	1.80	0.60	1.10	0.15	0.10

Packaging Quantity

Part Number	Packaging Option	Quantity
SCF005-1206RB	Tape & Reel	3500 PCS

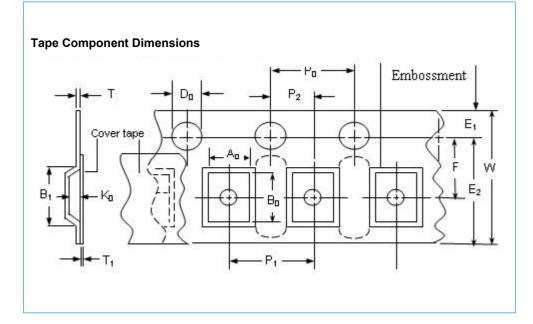
Ltd.



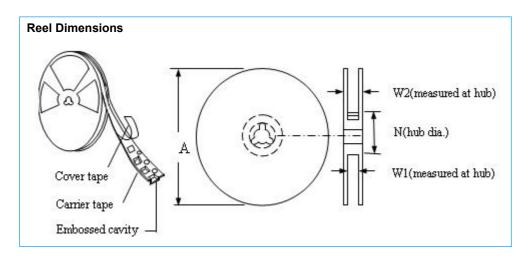


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Tape Specifications and Reel Specifications (Unit: mm)



Symbol	Dimensions
W	8.15+0.15/-0.3
P ₀	4.0±0.10
P ₁	4.0±0.10
P ₂	2.0±0.05
A ₀	1.95±0.10
B ₀	3.65±0.10
D ₀	1.55±0.05
F	3.50±0.05
E ₁	1.75±0.10
Т	0.20±0.10
Leader min.	390
Trailer min.	160



Symbol	Dimensions
A	178±1.0
N	59±1.0
W1	8.5+1.0/-0.2
W2	12.0±1.0

Warning



- **u** Operation beyond the specified maximum ratings or improper use may result in damage and possible electrical arcing and/or flame.
- **u** PPTC device are intended for occasional over-current protection. Application for repeated over-current condition and/or prolonged trip are not anticipated.
- **u** Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.